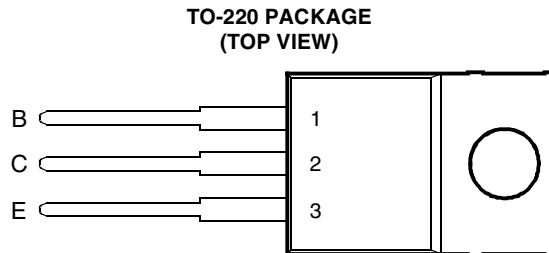


- 
- 40 W at 25°C Case Temperature
- 2 A Continuous Collector Current
- 3 A Peak Collector Current
- Typical  $t_f = 200$  ns at 25°C



Pin 2 is in electrical contact with the mounting base.

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#### absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING	SYMBOL	VALUE	UNIT
Collector-base voltage ( $I_E = 0$ )	$V_{CBO}$	800	V
Collector-emitter voltage ( $V_{BE} = 0$ )	$V_{CES}$	800	V
Collector-emitter voltage ( $I_B = 0$ )	$V_{CEO}$	400	V
Continuous collector current	$I_C$	2	A
Peak collector current (see Note 1)	$I_{CM}$	3	A
Continuous device dissipation at (or below) 25°C case temperature	$P_{tot}$	40	W
Operating junction temperature range	$T_j$	-65 to +150	°C
Storage temperature range	$T_{stg}$	-65 to +150	°C

NOTE 1: This value applies for  $t_p \leq 2$  ms, duty cycle  $\leq 2\%$ .

#### PRODUCT INFORMATION

**electrical characteristics at 25°C case temperature (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{CEO(sus)}$ Collector-emitter sustaining voltage	$I_C = 0.1 \text{ A}$ $L = 25 \text{ mH}$ (see Note 2)	400			V
$I_{CES}$ Collector-emitter cut-off current	$V_{CE} = 800 \text{ V}$ $V_{BE} = 0$ $V_{CE} = 800 \text{ V}$ $V_{BE} = 0$ $T_C = 125^\circ\text{C}$			0.2 1	mA
$I_{EBO}$ Emitter cut-off current	$V_{EB} = 5 \text{ V}$ $I_C = 0$			1	mA
$h_{FE}$ Forward current transfer ratio	$V_{CE} = 5 \text{ V}$ $I_C = 0.1 \text{ A}$ (see Notes 3 and 4)		35		
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 0.03 \text{ A}$ $I_C = 0.3 \text{ A}$ $I_B = 0.2 \text{ A}$ $I_C = 1 \text{ A}$ (see Notes 3 and 4)			0.8 1	V
$V_{BE(sat)}$ Base-emitter saturation voltage	$I_B = 0.2 \text{ A}$ $I_C = 1 \text{ A}$ (see Notes 3 and 4)			1.1	V
$f_t$ Current gain bandwidth product	$V_{CE} = 10 \text{ V}$ $I_C = 0.2 \text{ A}$		12		MHz
$C_{ob}$ Output capacitance	$V_{CB} = 20 \text{ V}$ $I_E = 0$ $f = 0.1 \text{ MHz}$		60		pF

NOTES: 2. Inductive loop switching measurement.

3. These parameters must be measured using pulse techniques,  $t_p = 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

5. To obtain  $f_t$  the  $[h_{FE}]$  response is extrapolated at the rate of -6 dB per octave from  $f = 1 \text{ MHz}$  to the frequency at which  $[h_{FE}] = 1$ .

**thermal characteristics**

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			2.5	°C/W

**resistive-load-switching characteristics at 25°C case temperature (unless otherwise noted)**

PARAMETER	TEST CONDITIONS <sup>†</sup>	MIN	TYP	MAX	UNIT
$t_{on}$ Turn on time	$I_C = 1 \text{ A}$ $I_{B(on)} = 0.2 \text{ A}$ $I_{B(off)} = -0.4 \text{ A}$		0.25	0.5	μs
$t_s$ Storage time	$V_{CC} = 250 \text{ V}$ (see Figures 1 and 2)		1.8		μs
$t_f$ Fall time			0.2		μs
$t_f$ Fall time	$I_C = 1 \text{ A}$ $I_{B(on)} = 0.2 \text{ A}$ $I_{B(off)} = -0.4 \text{ A}$ $V_{CC} = 250 \text{ V}$ $T_C = 95^\circ\text{C}$			0.4	μs

<sup>†</sup> Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

**PRODUCT INFORMATION**

## PARAMETER MEASUREMENT INFORMATION

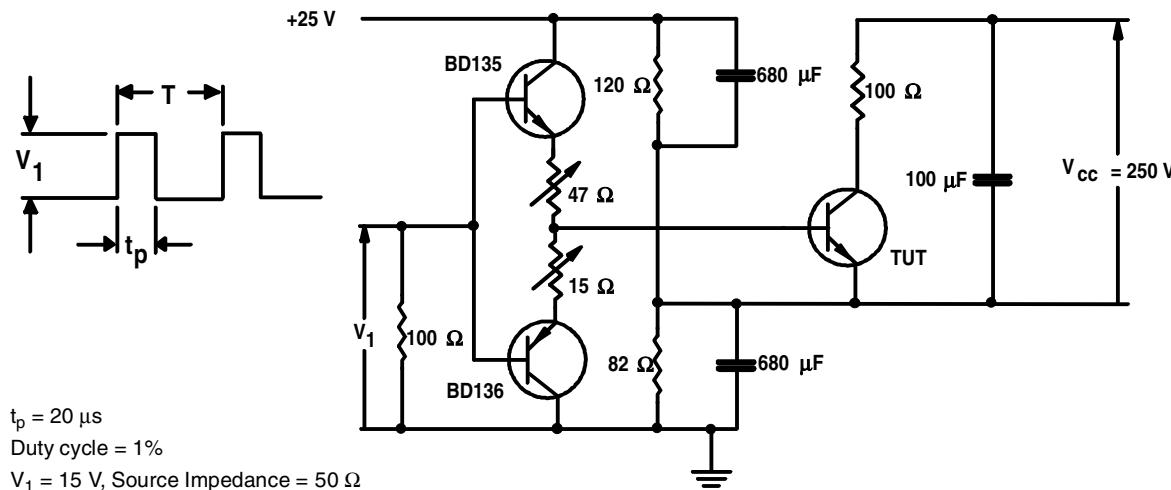


Figure 1. Resistive-Load Switching Test Circuit

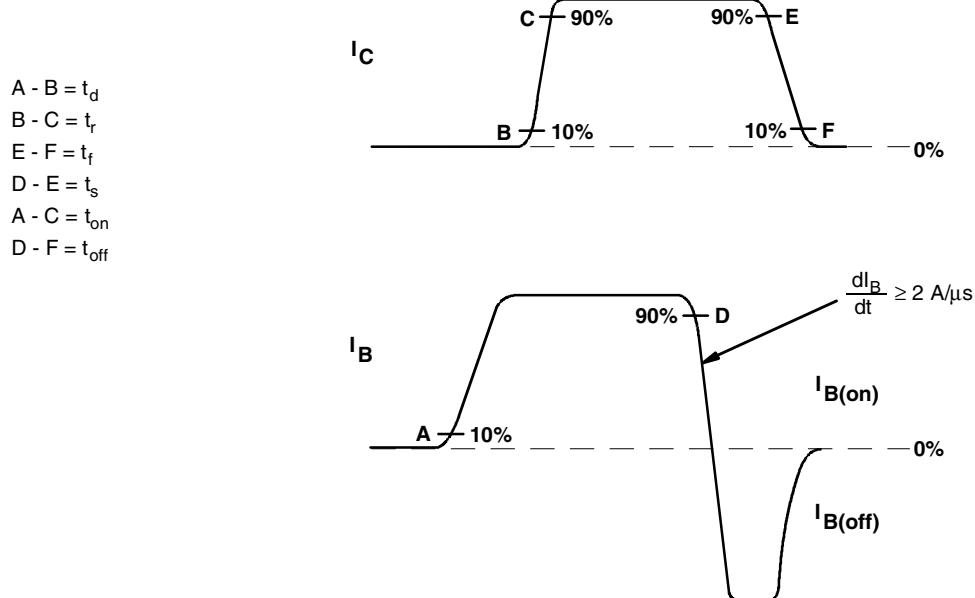


Figure 2. Resistive-Load Switching Waveforms

## PRODUCT INFORMATION

### TYPICAL CHARACTERISTICS

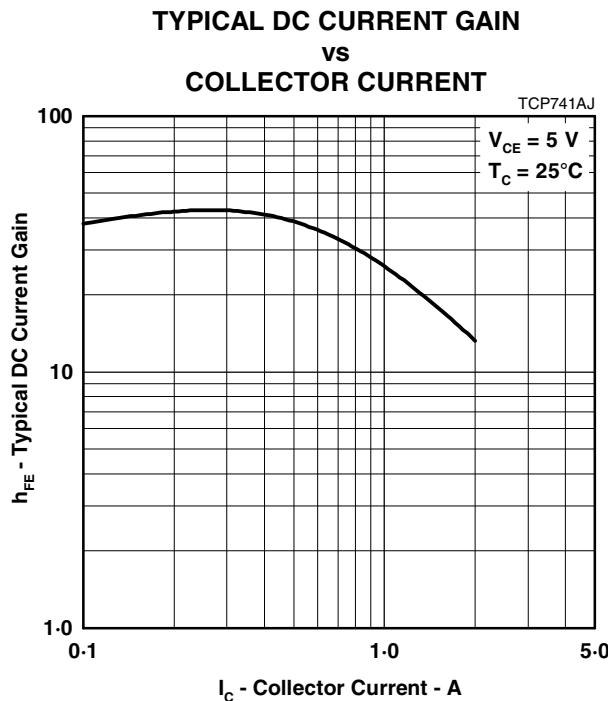


Figure 3.

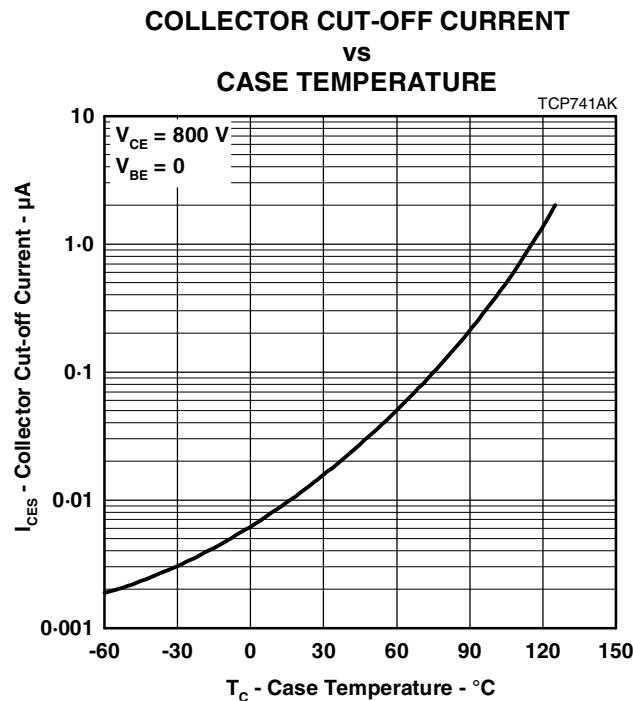


Figure 4.

### MAXIMUM SAFE OPERATING REGIONS

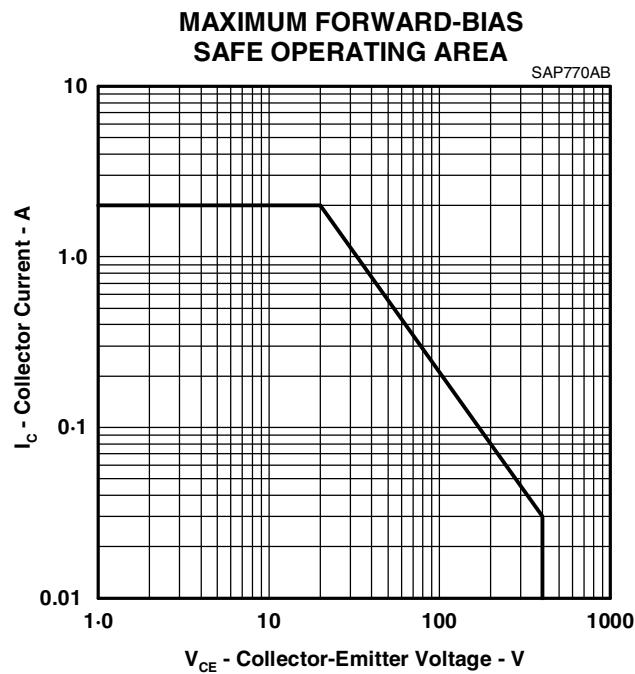


Figure 5.

### PRODUCT INFORMATION

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Specifications are subject to change without notice.

## THERMAL INFORMATION

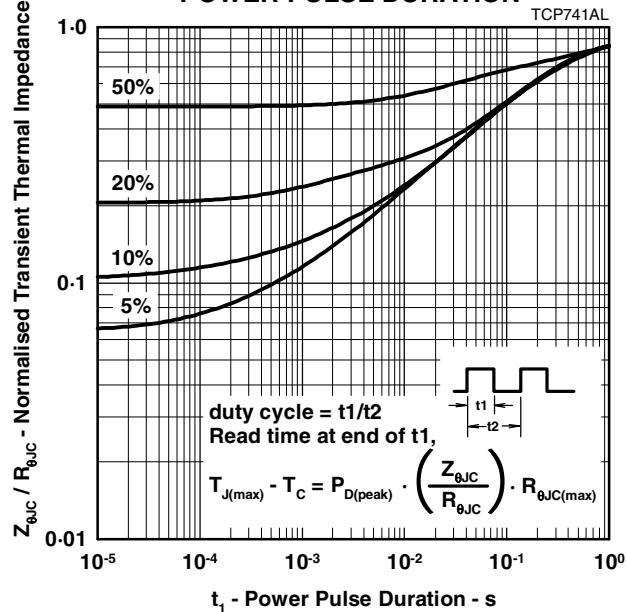
THERMAL RESPONSE JUNCTION TO CASE  
vs  
POWER PULSE DURATION

Figure 6.

## PRODUCT INFORMATION

AUGUST 1978 - REVISED SEPTEMBER 2002  
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